



深圳市一众显示科技有限公司

SHEN ZHEN TEAM SOURCE DISPLAY TECH. CO, LTD.

TFT-LCD Module Specification

Module NO.: TST070WSBE-61

Version: V1.0

APPROVAL FOR SPECIFICATION

APPROVAL FOR SAMPLE

For Customer's Acceptance:	
Approved by	Comment

Team Source Display:		
Presented by	Reviewed by	Organized by

Version No.	Date	Content	Remark
V1.0	2020-5-28	Initial Release	

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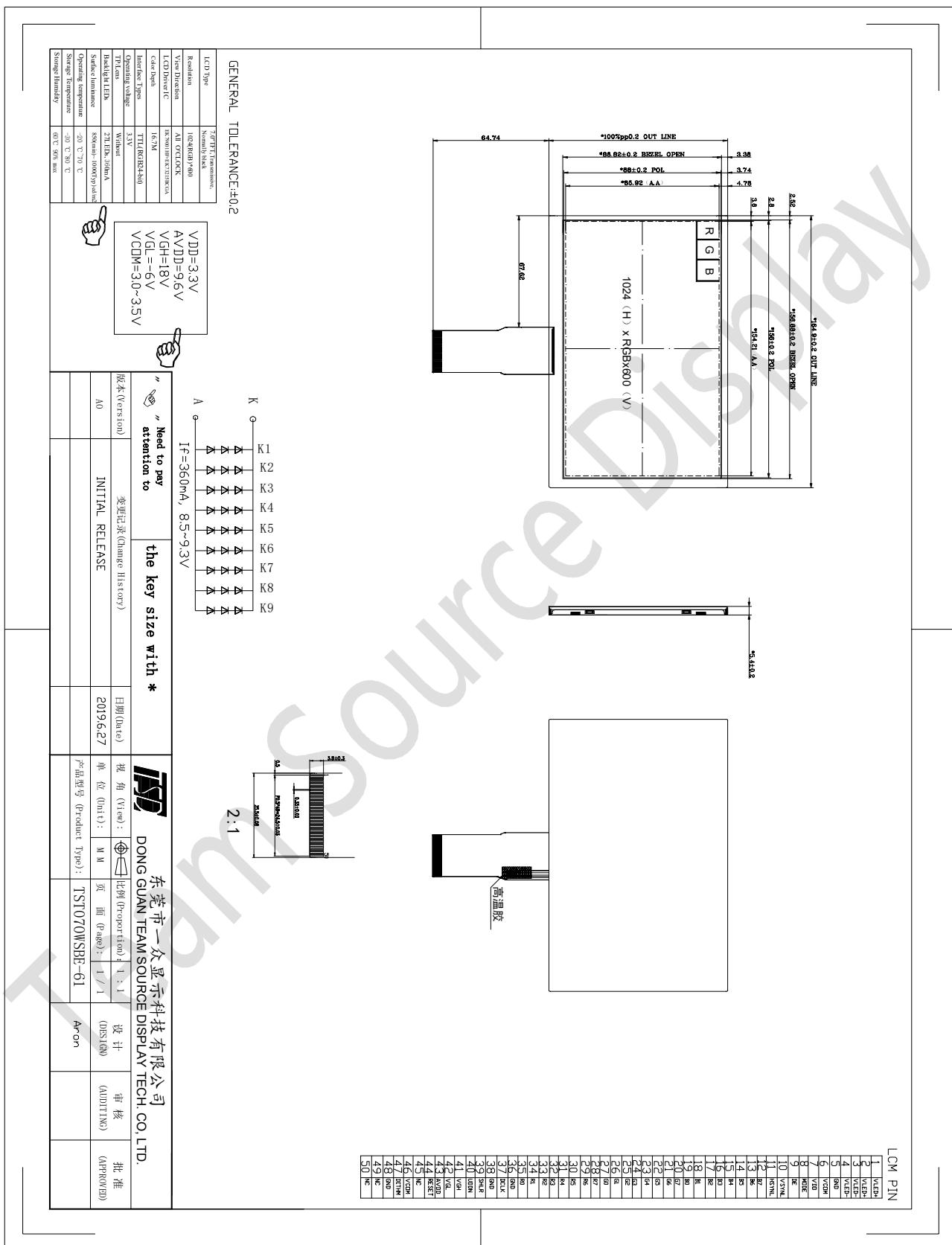
1 General Characteristics

ITEM	Specification	Unit
LCD Type	a-Si TFT,Transmissive,Normally black,IPS	-
LCD Size	7.0	inch
Resolution (W x H)	1024x (RGB) × 600	pixel
LCMoutline size	164.9(H) x 100(V) x5.4(T)	mm
Active Area	154.21 (H) x 85.92 V	mm
Dot Pitch	0.0642(H) × 0.1790(V)	mm
Viewing Direction	ALL o'clock	-
Gray Scale Inversion Direction	ALL o'clock	-
Color Depth	16.7M	-
Pixel Arrangement	RGB-stripe	-
Backlight Type	27 LEDs, 360mA	-
Surface Luminance	850(Min),1000(TYP)	cd/m ²
Lens Surface Treatment	Clear	-
LCD Driver IC	EK79001HF+EK73215BCGA	-
Interface Type	RGB (TTL)	-
Input Voltage	3.3	V
With/Without TP	Without	-
Weight	TBD	g

Note 1: RoHS compliant

Note 2: LCM weight tolerance: ± 5%.

2 Product drawings



3 Interface description

3.1 LCM interface description

Pin No.	Symbol	I/O	Function	Remark
1	V _{LED+}	P	Power for LED backlight (Anode)	
2	V _{LED+}	P	Power for LED backlight (Anode)	
3	V _{LED-}	P	Power for LED backlight (Cathode)	
4	V _{LED-}	P	Power for LED backlight (Cathode)	
5	GND	P	Power ground	
6	V _{COM}	I	Common voltage	
7	V _{DD}	P	Power for Digital Circuit	
8	MODE	I	DE/SYNC mode select	Note 1
9	DE	I	Data Input Enable	
10	VSYNC	I	Vertical Sync Input	
11	H SYNC	I	Horizontal Sync Input	
12	B7	I	Blue data(MSB)	
13	B6	I	Blue data	
14	B5	I	Blue data	
15	B4	I	Blue data	
16	B3	I	Blue data	
17	B2	I	Blue data	
18	B1	I	Blue data	Note 2
19	B0	I	Blue data(LSB)	Note 2
20	G7	I	Green data(MSB)	
21	G6	I	Green data	
22	G5	I	Green data	
23	G4	I	Green data	
24	G3	I	Green data	
25	G2	I	Green data	
26	G1	I	Green data	Note 2

27	G0	I	Green data(LSB)	Note 2
28	R7	I	Red data(MSB)	
29	R6	I	Red data	
30	R5	I	Red data	
31	R4	I	Red data	
32	R3	I	Red data	
33	R2	I	Red data	
34	R1	I	Red data	Note 2
35	R0	I	Red data(LSB)	Note 2
36	GND	P	Power Ground	
37	DCLK	I	Sample clock	Note 3
38	GND	P	Power Ground	
39	SHLR	I	Left / right selection	Note 4,5
40	UDDN	I	Up/down selection	Note 4,5
41	V _{GH}	P	Gate ON Voltage	
42	V _{GL}	P	Gate OFF Voltage	
43	A _{V_{DD}}	P	Power for Analog Circuit	
44	RESET	I	Global reset pin.	Note 6
45	NC	-	No connection	
46	V _{COM}	I	Common Voltage	
47	DITHB	I	Dithering function	Note 7
48	GND	P	Power Ground	
49	NC	-	No connection	
50	NC	-	No connection	

I: input, O: output, P: Power

Note 1: DE/SYNC mode select. Normally pull high.

When select DE mode, MODE="1", VS and HS must pull high.

When select SYNC mode, MODE= "0", DE must be grounded.

Note 2: When input 18 bits RGB data, the two low bits of R,G and B data must be grounded.

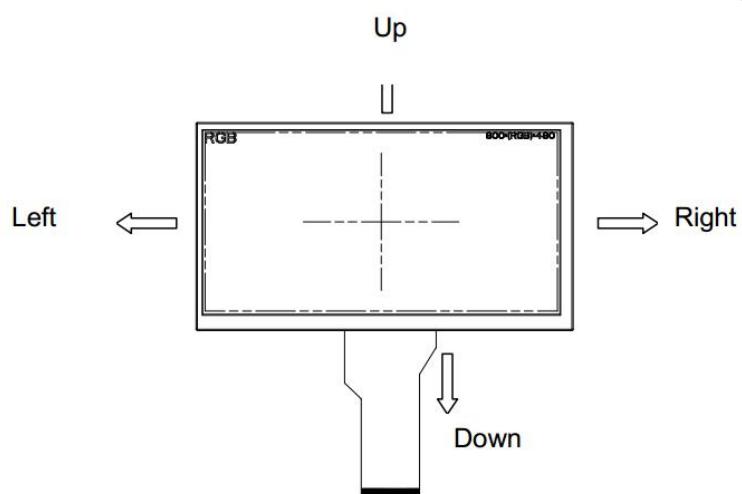
Note 3: Data shall be latched at the falling edge of DCLK.

Note 4: Selection of scanning mode

Setting of scan control input		Scanning direction
U/D	L/R	
GND	DV _{DD}	Up to down, left to right
DV _{DD}	GND	Down to up, right to left
GND	GND	Up to down, right to left
DV _{DD}	DV _{DD}	Down to up, left to right

Note 5: Definition of scanning direction.

Refer to the figure as below:



Note 6: Global reset pin. Active low to enter reset state. Suggest to connect with an RC reset circuit for stability. Normally pull high.

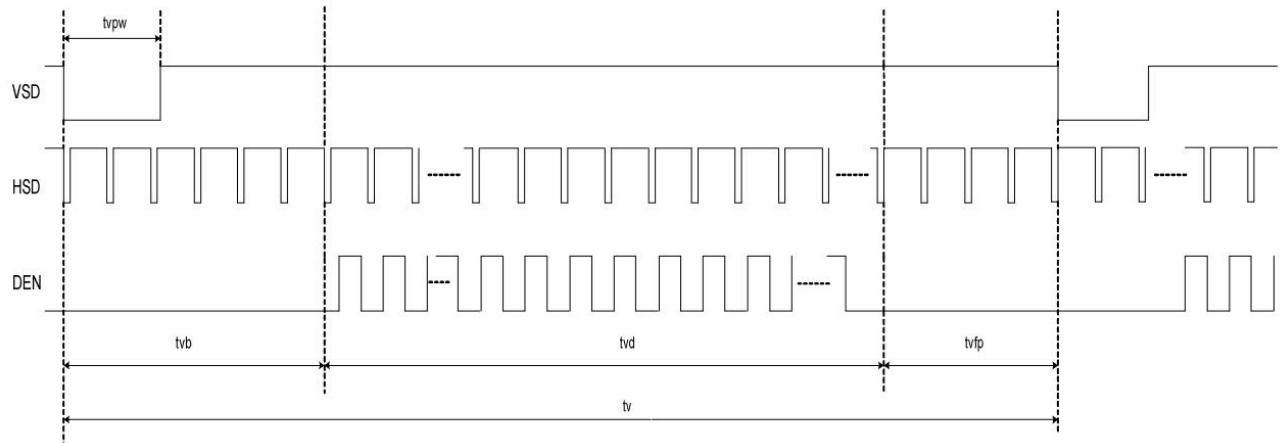
Note 7: Dithering function enable control, normally pull high.

When DITHB="1", Disable internal dithering function,

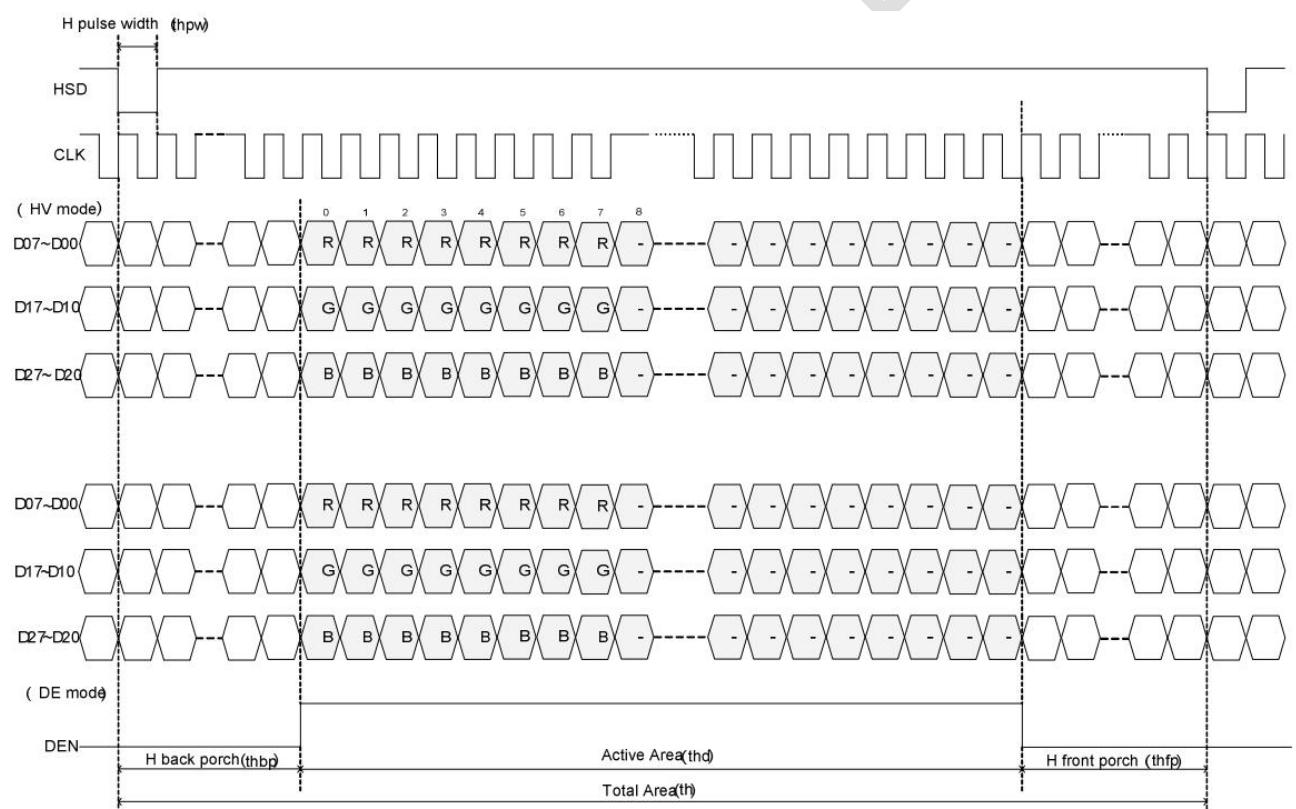
When DITHB="0", Enable internal dithering function,

4 Timing Characteristics

4.1 TTL Interface Timing



Vertical input timing



Horizontal input timing

DE mode

Parameter	Symbol	Value			Unit
		Min.	Typ.	Max.	
DCLK frequency @Frame rate=60hz	fclk	40.8	51.2	67.2	Mhz
Horizontal display area	thd		1024		DCLK
H SYNC period time	th	1114	1344	1400	DCLK
H SYNC blanking	thb+thfp	90	320	376	DCLK
Vertical display area	tvd		600		H
V SYNC period time	tv	610	635	800	H
V SYNC blanking	tvb+tvfp	10	35	200	H

HV mode

Horizontal input timing

Parameter	Symbol	Value			Unit	
Horizontal display area	thd	1024			DCLK	
DCLK frequency@ Frame rate=60hz	fclk	Min.	Typ.	Max.		
		44.9	51.2	63	Mhz	
1 Horizontal Line	th	1200	1344	1400		
H SYNC pulse width	thpw	1			DCLK	
		—				
		140				
H SYNC back porch	thbp	160	160	160		
H SYNC front porch	thfp	16	160	216		

Vertical input timing

Parameter	Symbol	Value			Unit
		Min.	Typ.	Max.	
Vertical display area	tvd		600		H
V SYNC period time	tv	624	635	750	H
V SYNC pulse width	tvpw	1	—	20	H
V SYNC back porch	tvb	23	23	23	H
V SYNC front porch	tvfp	1	12	127	H

5 Absolute Maximum Ratings

PARAMETER	SYMBOL	MIN	MAX	UNIT
Supply Voltage for Analog	VDD	-0.5	5.0	V
Operating Temperature	TOP	-20	70	° C
Storage Temperature	TST	-30	80	° C
Humidity	RH	-	90%(Max 60° C)	RH

6 Electrical Characteristics

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
Analog operating voltage	VDD	2.3	3.3	3.6	V
Power supply input	AVDD	8.0	9.6	13.5	V
Input Current	IDD	-	TBD	-	mA
Gate on voltage	VGH	17	18	19	V
Gate off voltage	VGL	-5.5	-6	-6.5	
Input signal voltage	VCOM	3.0	3.2	3.5	

7 Backlight Characteristics

ITEM	SYMBOL	MIN	TYP	MAX	UNIT
Voltage for LED backlight	V _f	8.5	9.0	9.3	V
Current for LED backlight	I _f	-	360	-	mA
Power consumption	W _{bl}	-	3240	-	mW
Uniformity	Avg	75	-	-	%
LED Life Time	-	30000	40000	-	Hrs

Note:

1. The LED life time is defined as the module brightness decrease to 50% original brightness at Ta=25°C, 60%RH ±5 %.
2. The life time of LED will be reduced if LED is driven by high current, high ambient temperature and humidity conditions.
3. Typical operating life time is an estimated data.
4. Permanent damage to the device may occur if maximum values are exceeded or reverse voltage is loaded .Functional operation should be restricted to the conditions described under normal operating conditions.

8 LCD Optical specifications

Item	Symbol	Condition	Specification			Unit	Remark
			Min	Typ	Max		
Response time (By Quick)	Tr+Tf	$\theta = 0^\circ$	-	25	40	ms	Note 5
Contrast ratio	CR	$\theta = 0^\circ$	-	800	-		Note 2,6
Viewing angle	Top	$CR \geq 10$	80	85	-	Deg.	Note 2,6,7
	Bottom	$CR \geq 10$	80	85	-		
	Left	$CR \geq 10$	80	85	-		
	Right	$CR \geq 10$	80	85	-		
Color chromaticity (CIE1931)	Wx	$\theta = 0^\circ$	0.274	0.304	0.334		Note 3
	Wy		0.305	0.335	0.365		
	Rx		-	-	-		
	Ry		-	-	-		
	Gx		-	-	-		
	Gy		-	-	-		
	Bx		-	-	-		
	By		-	-	-		
	NTSC		-	50%	-		Note 3

Note 1: Ambient temperature = 25°C.

Note 2: To be measured with a viewing cone of 2° by Topcon luminance meter BM-7.

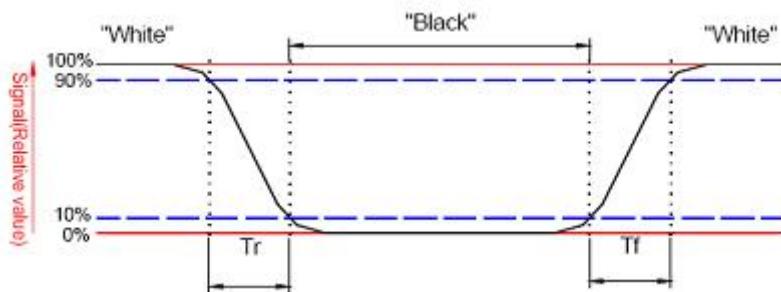
Note 3: To be measured with Otsuta chromaticity meter LCF-2100M, CF only measure under C light simulation.

Note 4: BOE shipping status is cell without polarizer. Transmittance of Specification is cell with polarizer.

The tolerance of Transmittance is $\pm 10\%$.

Note 5: Definition of response time:

The output signals of TRD-100 are measured when the input signals are changed to "White" (falling time) and from "White" to "Black" (rising time), respectively. The interval is between the 10% and 90% of amplitudes. Refer to figure as below.

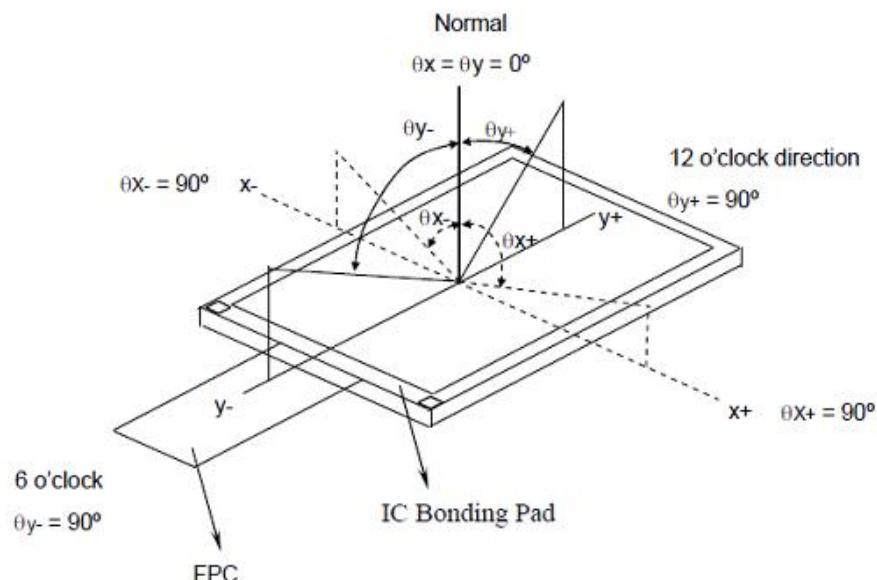


Note 6: Definition of contrast ratio:

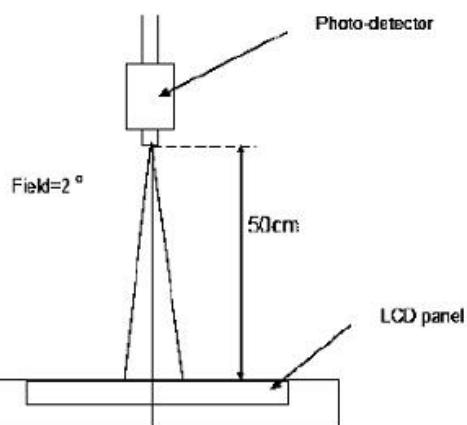
Contrast ratio is calculated by the following formula.

$$\text{Contrast ratio (CR)} = \frac{\text{Brightness on the "white" state}}{\text{Brightness on the "black" state}}$$

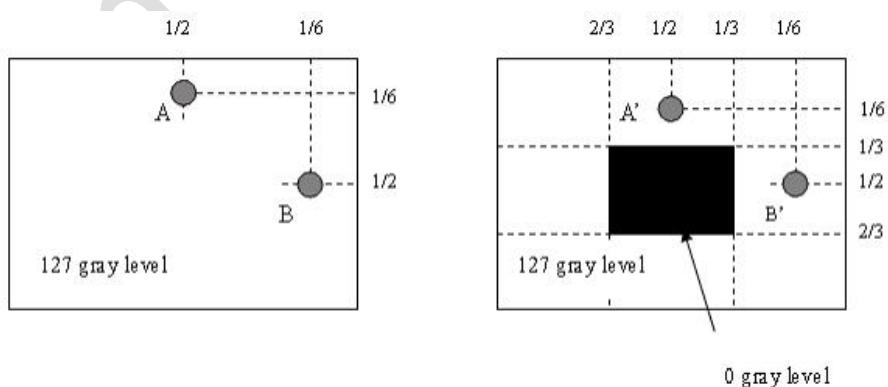
Note 7: Definition of viewing angle



Note 8: Optical characteristic measurement setup.



Note 9:



1 LA-LA' / LA x 100% = 2% max., LA and LA' are brightness at location A and A'.

1 LB-LB' / LB x 100% = 2% max., LB and LB' are brightness at location B and B'.

9 RELIABILITY TEST

NO.	TEST ITEM	TEST CONDITION	INSPECTION AFTER TEST
1	High Temperature Storage	80±2°C/96 hours	
2	Low Temperature Storage	-30±2°C/96 hours	
3	High Temperature Operating	70±2°C/96 hours	
4	Low Temperature Operating	-20±2°C/96 hours	
5	Temperature Cycle	-30±2°C ~ 25~ 80± 2°C × 10 cycles (30 min.) (5min.) (30min.)	
6	Damp Proof Test	60°C ±5°C × 90%RH/96 hours	
7	Packing Drop Test	Height: 60 cm 1 corner, concrete floor	
8	Electrostatic Discharge Test	C=150pF, R=330 Ω Air: ±8KV 150pF/330Ω 30 times Contact: ±4KV,20 times	<p>Inspection after 2~4 hours storage at room temperature and humidity. The condensation is not accepted. The sample shall be free from defects:</p> <ol style="list-style-type: none"> 1. Air bubble in the LCD 2. Seal leak 3. Non-display 4. Missing segments 5. Glass crack

10 Suggestions for using LCD modules

10.1 Handling of LCM

1. The LCD screen is made of glass. Don't give excessive external shock, or drop from a high place.
2. If the LCD screen is damaged and the liquid crystal leaks out, do not lick and swallow. When the liquid is attach to your hand, skin, cloth etc, wash it off by using soap and water thoroughly and immediately.
3. Don't apply excessive force on the surface of the LCM.
4. If the surface is contaminated, clean it with soft cloth. If the LCM is severely contaminated, use Isopropyl alcohol/Ethyl alcohol to clean. Other solvents may damage the polarizer. The following solvents is especially prohibited: water , ketone Aromatic solvents etc.
5. Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
6. Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
7. Don't disassemble the LCM.
8. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - Be sure to ground the body when handling the LCD modules.
 - Tools required for assembling, such as soldering irons, must be properly grounded.
 - To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions.
 - The LCD module is coated with a film to protect the display surface. Exercise care when peeling

off this protective film since static electricity may be generated.

9. Do not alter, modify or change the shape of the tab on the metal frame.

10. Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.

11. Do not damage or modify the pattern writing on the printed circuit board.

12. Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector

13. Except for soldering the interface, do not make any alterations or modifications with a soldering iron.

14. Do not drop, bend or twist LCM.

10.2 Storage

1. Store in an ambient temperature of 5 to 45 °C, and in a relative humidity of 40% to 60%. Don't expose to sunlight or fluorescent light.

2. Storage in a clean environment, free from dust, active gas, and solvent.

3. Store in antistatic container.

